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Serial No. :
Filed : February 24, 2006
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Attorney's Docket No.: 14225-
095US1 / F1040665WO00

Amendments to the Specification:

Please replace the abstract at page 21 with the following amended abstract:

--It is an object of the present invention to provide a circuit device in which a plurality of circuit elements including a circuit element having a hollow inside are sealed with resin, and to provide a method of manufacturing the same. A circuit device (~~10~~) has a first circuit element (~~13A~~) having a hollow inside and a plurality of second circuit elements (~~13B~~) electrically connected to the first circuit element (~~13A~~). The first and second circuit elements (~~13A~~) and (~~13B~~) are sealed with sealing resin (~~15~~). The distances by which the first circuit element (~~13A~~) is separated from the second circuit elements (~~13B~~) are longer than those by which the second circuit elements (~~13B~~) are separated from each other.--